

3.0x1.0mm RIGHT ANGLE SMD CHIP LED LAMP



ATTENTION

OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE **DEVICES**

Part Number: APFA3010SURKCGKQBDC

Hyper Red Green Blue

Features

- 3.0mmx1.0mm right angle SMT LED, 1.5mm thickness.
- Low power consumption.
- · Wide viewing angle.
- Ideal for backlight and indicator.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- Tinned pads for improved solderability.
- RoHS compliant.

Description

The Hyper Red source color devices are made with Al-GaInP on GaAs substrate Light Emitting Diode.

The Green source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.

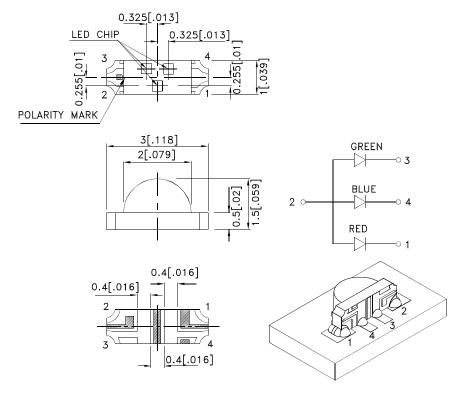
The Blue source color devices are made with InGaN Light Emitting Diode.

Static electricity and surge damage the LEDS.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

Package Dimensions



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.2(0.008") unless otherwise noted
- 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice 4. The device has a single mounting surface. The device must be mounted according to the specifications.

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Selection Guide

| Part No. | Dice | Lens Type | lv (mcd) [2] @ 20mA | | Viewing Angle [1] |
|---------------------|---------------------|-------------|------------------------|------|----------------------|
| | | 3,1 | Min. | Тур. | 201/2 |
| APFA3010SURKCGKQBDC | Hyper Red (AlGaInP) | | 120 | 220 | 120° |
| | Green (AlGaInP) | Water Clear | 30 | 50 | |
| | Blue (InGaN) | | 55 | 100 | |

- 1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value. 2. Luminous intensity/ luminous Flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

| Symbol | Parameter | Device | Тур. | Max. | Units | Test Conditions |
|--------|--------------------------|----------------------------|--------------------|-----------------|-------|-----------------|
| λpeak | Peak Wavelength | Hyper Red Green Blue | 650 574 468 | | nm | IF=20mA |
| λD [1] | Dominant Wavelength | Hyper Red Green Blue | 630 570 470 | | nm | IF=20mA |
| Δλ1/2 | Spectral Line Half-width | Hyper Red Green Blue | 28 20 25 | | nm | IF=20mA |
| С | Capacitance | Hyper Red Green Blue | 35 15 100 | | pF | VF=0V;f=1MHz |
| VF [2] | Forward Voltage | Hyper Red Green Blue | 1.95 2.1 3.3 | 2.5 2.5 4 | V | IF=20mA |
| lr | Reverse Current | Hyper Red Green Blue | | 10 10 50 | uA | VR=5V |

Notes:

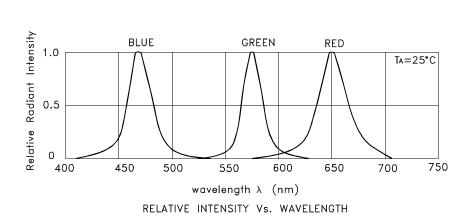
- 1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

Absolute Maximum Ratings at TA=25°C

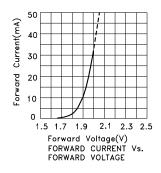
| Parameter | Hyper Red | Green | Blue | Units | | |
|--------------------------|----------------|-------|------|-------|--|--|
| Power dissipation | 75 | 75 | 120 | mW | | |
| DC Forward Current | 30 | 30 | 30 | mA | | |
| Peak Forward Current [1] | 185 | 150 | 150 | mA | | |
| Reverse Voltage | 5 | | | | | |
| Operating Temperature | -40°C To +85°C | | | | | |
| Storage Temperature | -40°C To +85°C | | | | | |

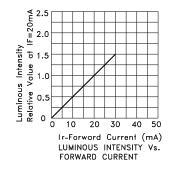
Notes: 1. 1/10 Duty Cycle, 0.1ms Pulse Width.

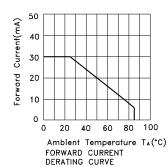
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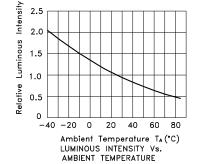


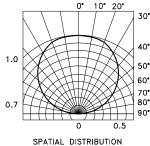
APFA3010SURKCGKQBDC **Hyper Red**





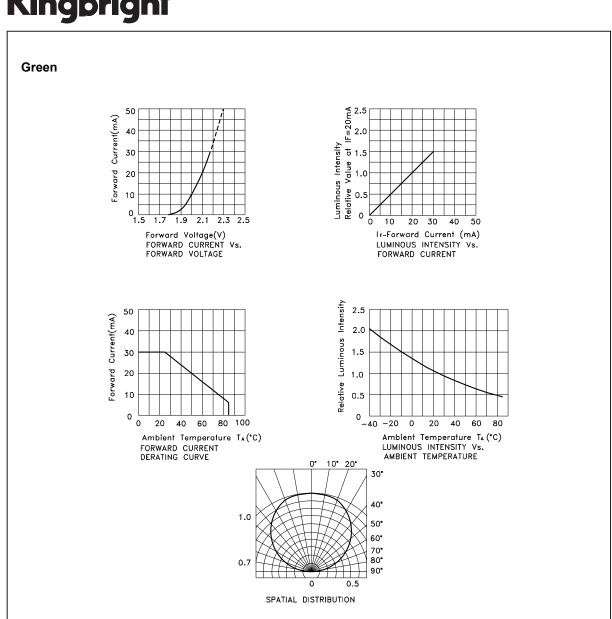




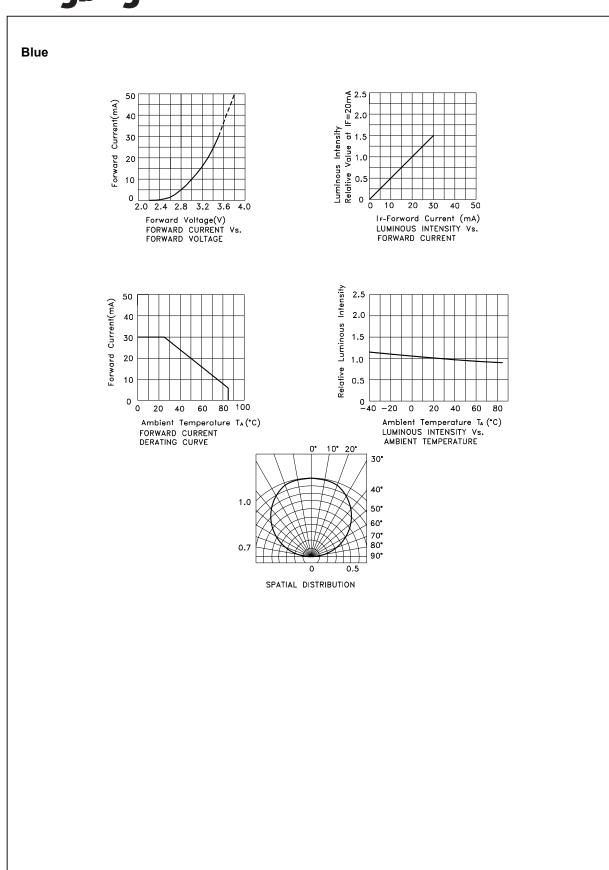


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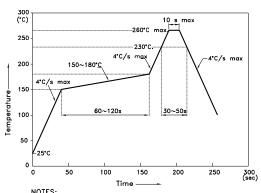
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Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



NOTES:

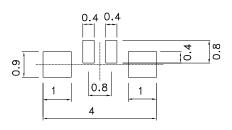
1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

3.Number of reflow process shall be 2 times or less.

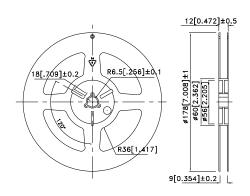
Recommended Soldering Pattern

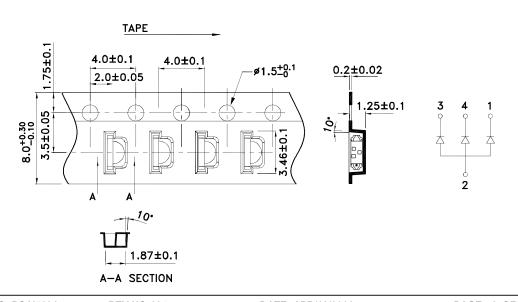
(Units : mm; Tolerance: ± 0.1)



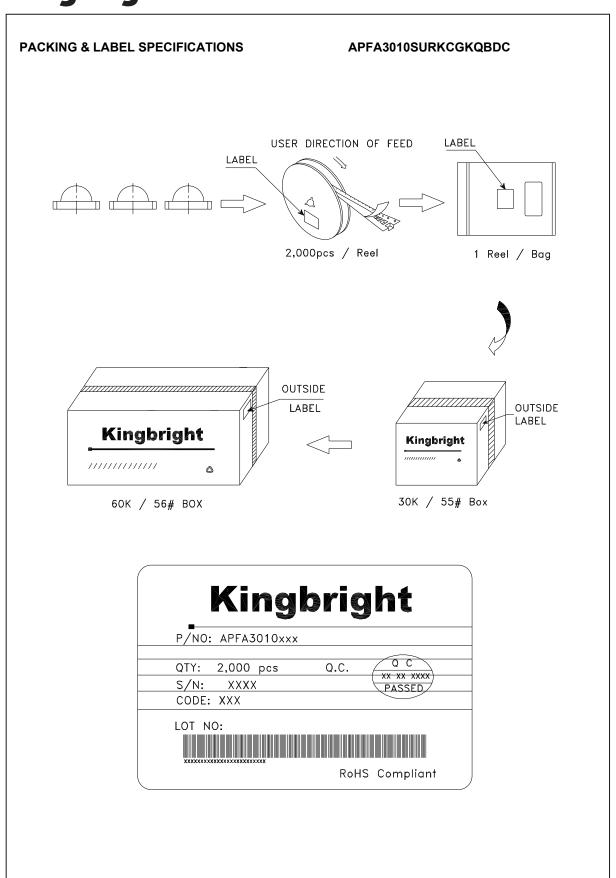
Tape Dimensions (Units: mm)

Reel Dimension





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